3U VITA 46 VPX & VITA 65 OpenVPX Processor Board

Fully rugged 3U SBC for extreme environments

- 2nd generation Intel[®] Core[™] i7
 2.20 GHz dual-core integrated processor
- Up to 8GB ECC-protected DDR3-1333, soldered down
- Intel[®] QM67 platform controller hub (PCH)
- 256Kbytes F-RAM
- PCI Express Fat Pipe data plane
- 1000BASE-BX/KX control plane
- SATA, USB and serial interfaces
- Integrated 2D/3D graphics with digital and VGA output
- One XMC site
- Optional rear transition module
- Extended temperature -40 °C to +85 °C and rugged variants
- Air and conduction cooled
- VITA 48 REDI two-level maintenance (2LM)

One of first in a new line of VPX products from Emerson Network Power, the 3U iVPX7223 features the dual-core 2nd generation Intel[®] Core[™] i7 2.20 GHz processor with integrated graphics and memory controller and the mobile Intel[®] QM67 PCH chipset with leading edge I/O functionality. This high compute density platform offers both high speed fabric connectivity with PCI Express and Gigabit Ethernet control plane connectivity with data transfer rates up to 5Gbps. On-board memory includes 4GB DDR3-1333 memory (designed for 8GB), embedded USB flash, and 256KB non-volatile Ferroelectric Random Access Memory (F-RAM). Additional connectivity includes three USB 2.0 ports, two serial ports, three SATA ports, eight GPIO, DisplayPort, VGA and one XMC site for maximum flexibility.

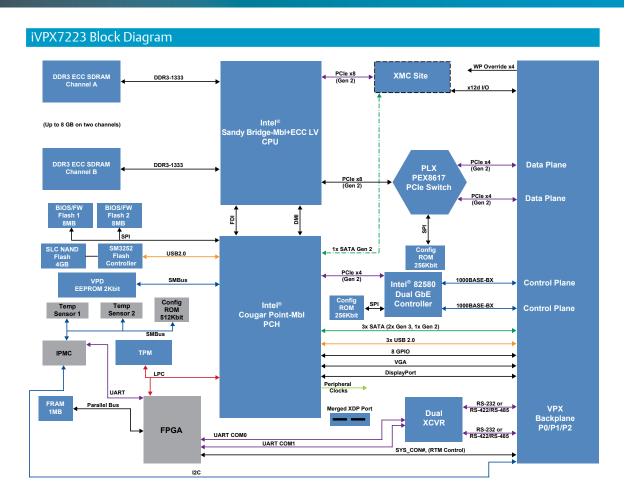
The iVPX7223 is a fully rugged SBC for extreme environments with extended shock, vibration, temperatures and conduction cooling. It is designed for a range of industrial, communication and military/aerospace applications.

The iVPX7223 software support includes Solid and Stable BIOS with password protection and a wide range of operating systems including Wind River VxWorks, Linux, Microsoft® Windows® Embedded Standard 2009, Red Hat Fedora, Green Hills INTEGRITY, and LynuxWorks LynxOS.









Specifications

PROCESSOR

- Dual-core 2nd generation Intel[®] Core[™] i7-2655LE, 2.20 GHz, 4MB L2 cache, 25 W
- Dual DDR3-800/1066/1333 memory controller
- Two (2) PCI Express (PCIe) root controllers with 16 lanes Gen2 PCIe (max. 5.0 GT/s)
- x4 DMI interface to platform controller hub (PCH)

CHIPSET

- Intel® QM67 PCH
- Eight (8) PCI Express root controllers and 8 lanes Gen2 PCIe (max. 5.0 GT/s)
- Six (6) 6x SATA controllers
- 14 USB 2.0 host controllers
- Three (3) digital displays (DP/eDP*/HDMI/DVI/ sDVO*)
- One (1) analog display (CRT/VGA)
- SPI interface (2 CS#)
- LPC interface
- SMBus
- Programmable interrupt controller, watchdog timer, real-time clock
- Gigabit Ethernet controller 10/100/1000BASE-T*

MEMORY

- 4GB dual-channel DDR3-1333 memory with ECC soldered down
- Support for 8GB memory

USER FLASH/NVRAM MEMORY

- 4GB embedded USB flash
- 256KB F-RAM (NVRAM)

BOOT FLASH MEMORY

- Dual UEFI in dual 8MB SPI flash devices
- Support for crisis recovery

BACKPLANE I/O

- Two (2) 1000BASE-BX/KX Ethernet (Ultra Thin Pipe control plane)
- Two (2) PCIe x4 Gen2 (Fat Pipe data plane)
 - One port configurable with non-transparent bridging capability)
- One (1) DisplayPort
- One (1) VGA
- Three (3) USB 2.0
- Three (3) SATA (2x Gen3, 1x Gen2)
- Two (2) RS-232/RS-422/RS-485
- Eight (8) GPIO
- XMC X12d I/O
- SMBus
- IPMC I²C
- Selective Read-Only Override pins
- RTM control signals

FRONT PANEL I/O (AIR COOLED ONLY)

- Air cooled
 - ▲ XMC front panel I/O
 - ▲ Reset switch
 - ▲ Status LEDs
- Conduction-cooled blade
 - Reset switch
 - ▲ Status LEDs

ETHERNET CONTROLLERS

- x4 PCle to 2x 1000BASE-BX/KX to OVPX backplane through 82580 Ethernet controller
- One (1) XMC site (1x SATA Gen2 routed to the XMC for an optional mutually-exclusive SSD mezzanine card)

OPENVPX PROFILES

- Payload module profile
 - ▲ MOD3-PAY-2F2U-16.2.3-3
- Payload slot profile
 - ▲ SLT3-PAY-2F2U-14.2.3
 - ▲ SLT3-PAY-1F1F2U-14.2.4

OPTIONAL TRANSITION MODULES

 Mini DisplayPort, VGA, USB 2.0, Ethernet, Serial, I²C, GPIO, SATA, XMC IO, write protect override switches

^{*} Not utilized in iVPX7223

OTHER FEATURES

- Watchdog unit
- Trusted Platform Module (TPM)
- Intel® vPro[™] Technology capable (supports Intel® TXT, VT, and TPM)
- VITA 46.11 system management IPMI V1.5 compliant
- Multiple 32-bit timers
- Temperature sensors
- Status and user LEDs
- Reset switch
- Locking ejector handles
- One of the CPU's two PCI Express ports is set up for future Gen3 compliance (going to the XMC site)

BIOS

UEFI BIOS

POWER REQUIREMENTS

- Maximum for 2.20 GHz (iVPX7220), 4GB memory variant
 - ▲ 5.0 V 58 W (Estimated)

MTBF

 Calculated per Telcordia SR-332, Issue 1 and based on a ground fixed, controlled environment assuming an inlet air temperature of between 0 °C and 50 °C. 200,000 hours

ELECTROMAGNETIC COMPATIBILITY (EMC)

- Intended for use in systems meeting the following regulations:
 - US: FCC Part 15, Subpart B, Class A (non-residential)
 - ▲ Canada: ICES-003, Class A (non-residential)
- Emerson board products are tested in a representative system to the following standards:
 - ▲ CE Mark per European EMC Directive 89/336/EEC with Amendments; Emissions: EN55022 Class B; Immunity: EN55024

DOCUMENTATION

- Installation Guide and Technical Reference Manual
- Hardware Release Notes
- Linux Installation and Programmer's Guides

ENP2 and ENP4 available for this product line.

Environmental Requirements				
Ruggedization Level ³	ENP1	ENP2	ENP3	ENP4
Method	Forced Air	Forced Air	Conduction	Conduction
Operating Temperature	0°C to +55°C	-40°C to +71°C	-40°C to +71°C	-40°C to +85°C
Storage Temperature	-40°C to +85°C	-50°C to +100°C	-50°C to +100°C	-50°C to +125°C
Vibration Sine (10min/axis)	2G, 5 to 500Hz	5G, 15 to 2000Hz	10G, 15 to 2000Hz	10G, 15 to 2000Hz
Vibration Random (1hr/axis)	.002g2/Hz, 15 to 2000Hz	.04g2/Hz, 15 to 2000Hz (8GRMS)1	0.1g2/Hz, 15 to 2000Hz (12GRMS) 2	0.1g2/Hz, 15 to 2000Hz (12GRMS)2
Shock	20g/11mS	30g/11mS	40g/11mS	40g/11mS
Humidity	to 95% RH4	to 95% RH4	to 95% RH4	to 95% RH4
Conformal Coating	Optional	Optional	Optional	Optional

Note 1: Flat 15-1000 Hz, -6db/octave 1000-2000 Hz [MIL-STD 810F Figure 514.5C-17]

Note 2: +3db/octave 15-300 Hz, Flat .1g2 300-1000 Hz, -6db/octave 1000-2000 Hz [MIL-STD 810F Figure 514.5C-8]

Note 3: Component and/or assembly screening shall be employed to satisfy feature/functional requirement (where feasible) when components are not available that meet ruggedization level requirements.

Ordering Information	
Part Number	Description
iVPX7223-220402	Intel [®] Core™ i7 2.20 GHz, 4GB DDR3 ENP2 .8" pitch
iVPX7223-220422	Intel Core i7 2.20 GHz, 4GB DDR3 ENP2 1" pitch
iVPX7223-220414	Intel Core i7 2.20 GHz, 4GB DDR3 ENP4 .85" pitch
iVPX7223-220414L	Intel Core i7 2.20 GHz, 4GB DDR3 ENP4 .85" pitch 2LM
iVPX7223-RTM2	7223 rear transition module ENP2

Please contact your sales representative for additional processor and memory variants.

SOLUTION SERVICES

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Emerson Network Power

Offices: Tempe, AZ U.S.A. 1 800 759 1107 or +1 602 438 5720
Paris, France +33 1 60 92 31 20 • Munich, Germany +44 1509 236490 • Tel Aviv, Israel +972 9 9560361
Hong Kong +852 2176 3540 • Shanghai, China +86 21 3395 0289 • Tokyo, Japan +81 3 5403 2730 • Seoul, Korea +82 2 3483 1500

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